## **Electronic Acknowledgement Receipt** FES ID: 1162721 Application Number: 10821438 Confirmation Number: 1354 Sidewall spacer for semiconductor device and fabrication method Title of Invention: thereof First Named Inventor: Rong-Hui Kao Customer Number: 47390 Filer: Daniel R. McClure Filer Authorized By: Attorney Docket Number: 252011-2210 Receipt Date: 20-AUG-2006 Filing Date: 09-APR-2004 Time Stamp: 08:57:24 Application Type: Utility International Application Number: Payment information:

## File Listing:

Submitted with Payment

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
1	Amendment - After Non-Final Rejection	00413256.pdf	158290	no	12

no

warnings:	
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## New Applications Under 35 U.S.C. 111

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

## National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/IDO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filling Receipt, in due course.